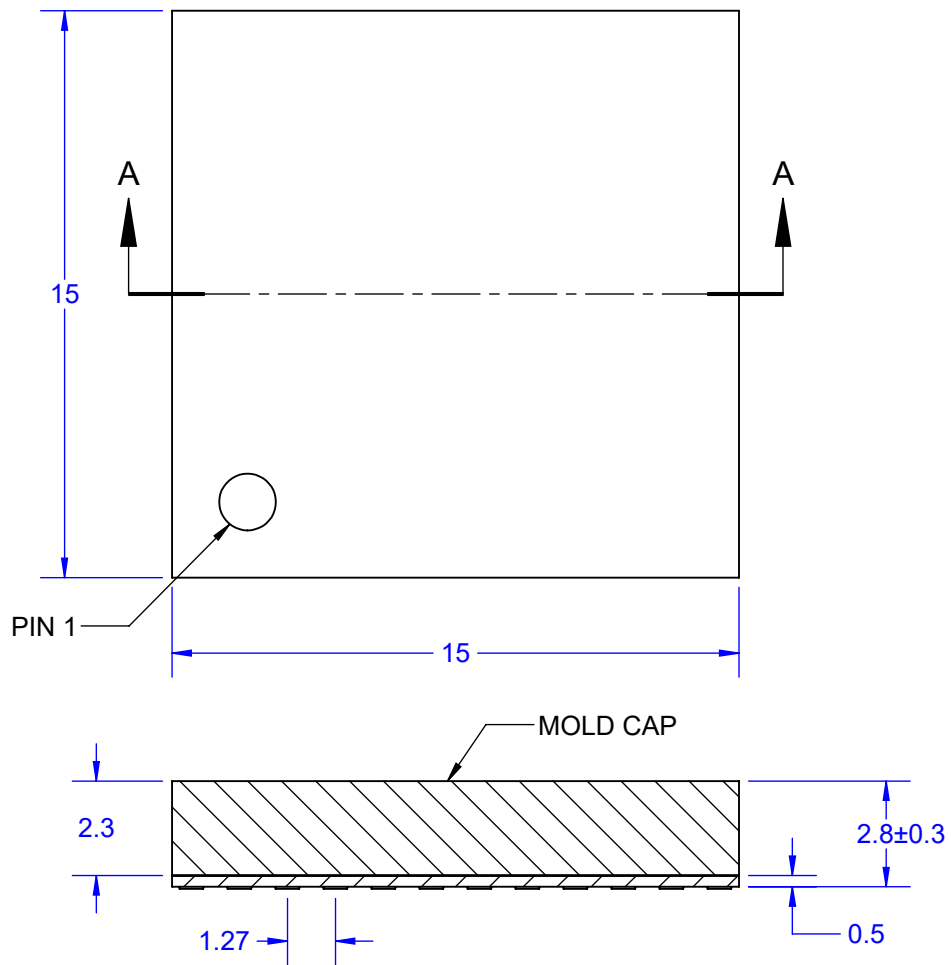
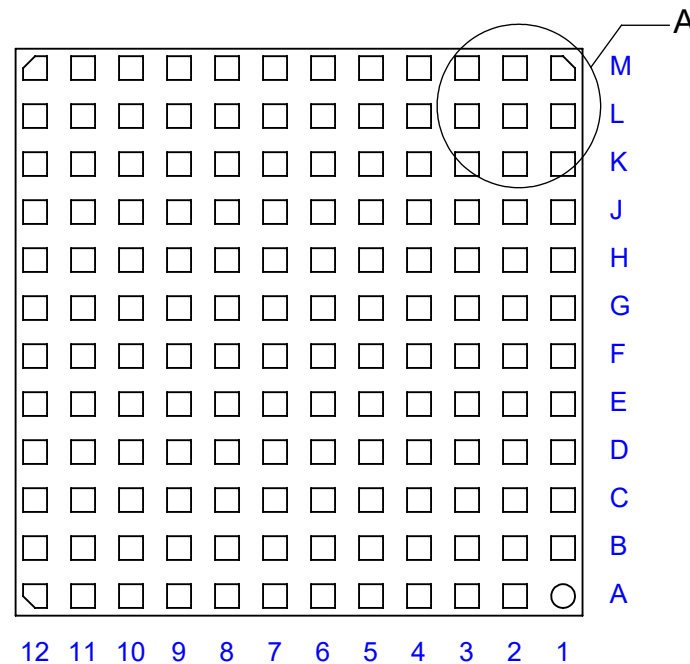


### TOP VIEW

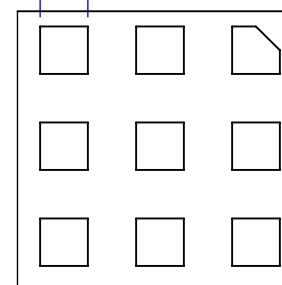


SECTION A-A

### BOTTOM VIEW



0.630±0.025 SQ. 143x



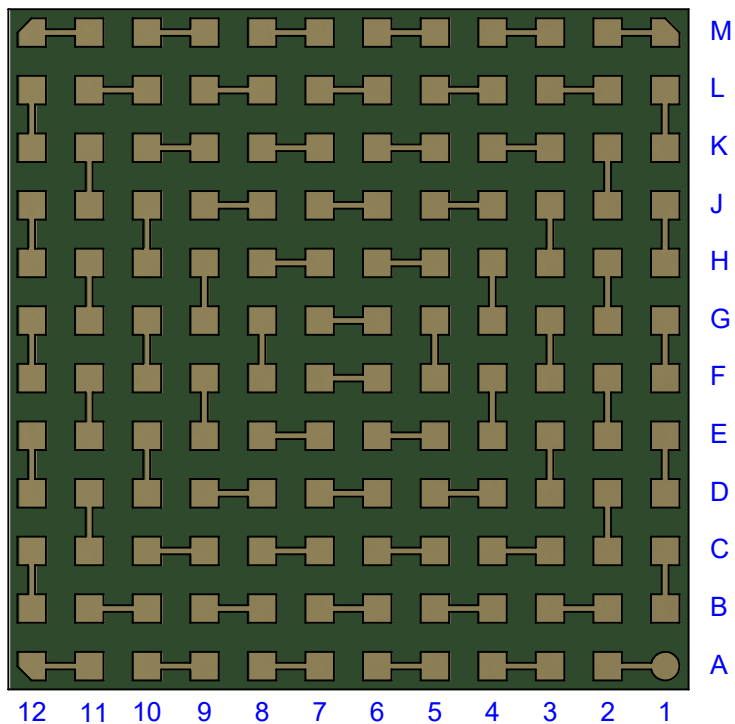
DETAIL A  
SCALE 10 : 1

Notes: (Unless Otherwise Specified).

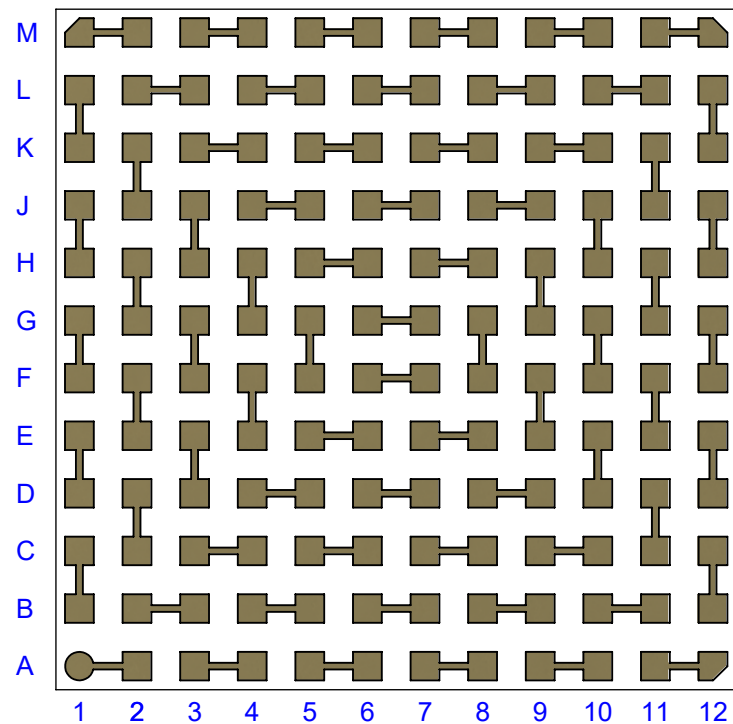
- 1) ALL DIMENSIONS ARE IN MM.
- 2) SUBSTRATE MATERIAL: BT.
- 3) DAISY CHAIN PATTERN (SEE PAGE 2).
- 4) PAD: Cu WITH Ni Au (ENIG) Plating.
- 5) MSL-3 RECOMMENDED BAKING 24 HOURS @125°C TO REMOVE MOISTURE PRIOR TO SOLDERING TO PC BOARD.

APPROVALS	DATE	<b>TopLine<sup>®</sup></b>		
DRAWN T. Au	8/5/2021			
ENG M. Hart	8/5/2021	TITLE LGA144T1.27G-DC126 DAISY CHAIN		
MFG		SCALE	SIZE	DRAWING NO.
QA		5:1	A	521260
CUST				REV B
REVISED		DO NOT SCALE DRAWING		SHEET 1 OF 5

# DAISY CHAIN PATTERN INTERNAL DEVICE PAD VIEW



# X-RAY VIEW FROM TOP

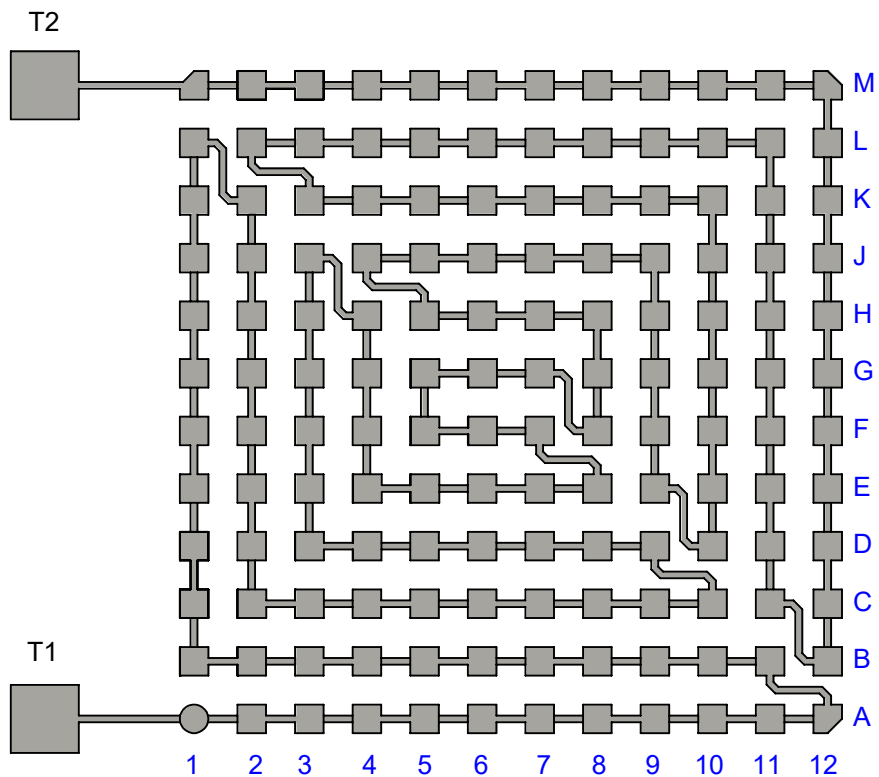


**Notes:**

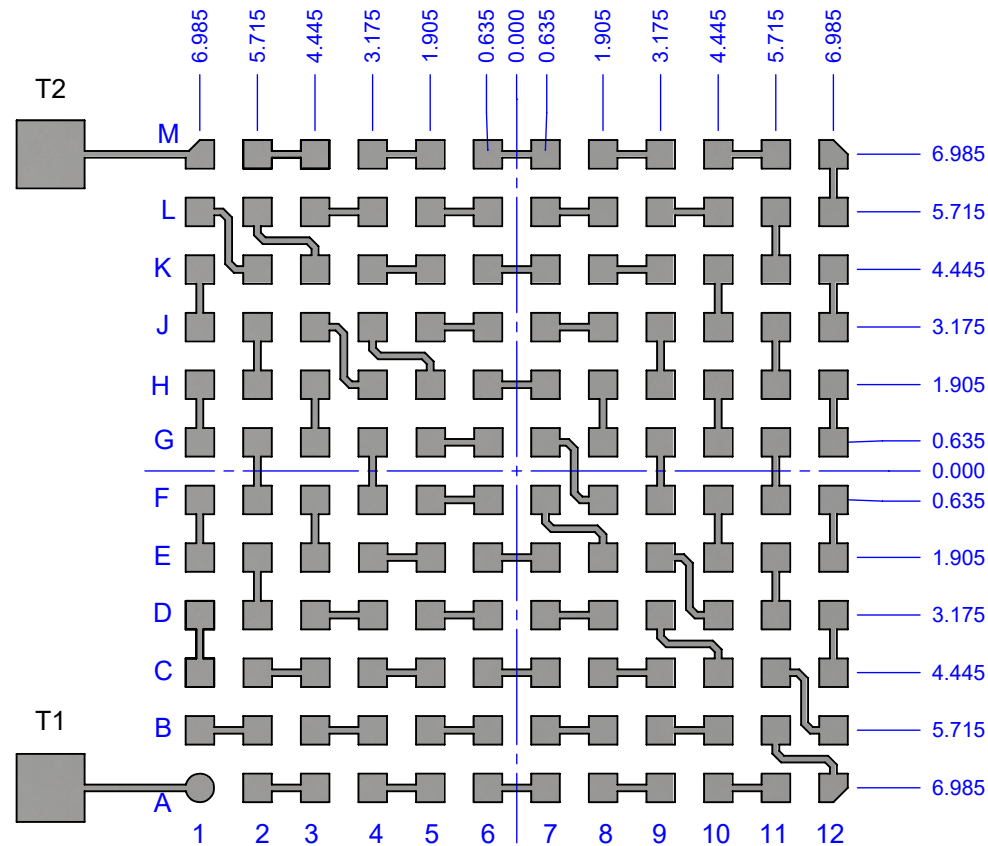
- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.
- 2) DIMENSIONS ARE mm.

<b>TopLine<sup>®</sup></b>			
TITLE		LGA144T1.27G-DC126 DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
16:1	A	521260	B
DO NOT SCALE DRAWING			SHEET 2 OF 5

## AFTER MOUNTING VIEW FROM TOP



## PCB LAYOUT TOP VIEW



### Notes:

- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.
- 2) DIMENSIONS ARE mm.

**TopLine**

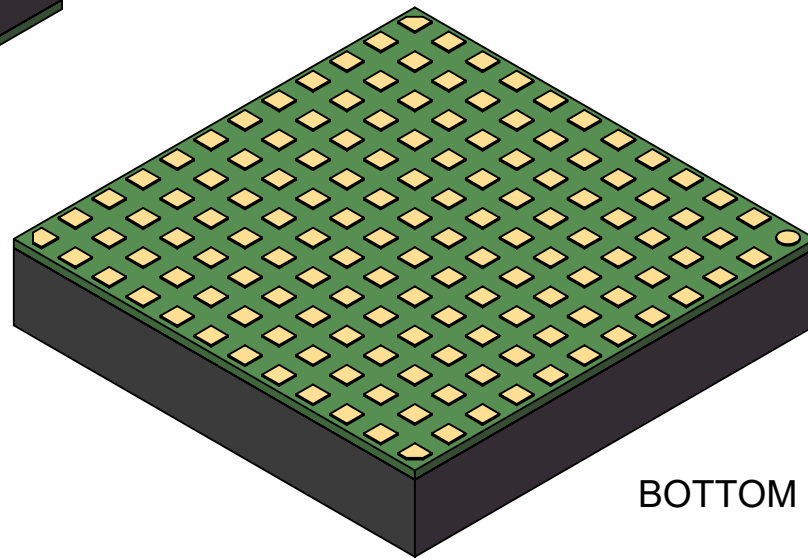
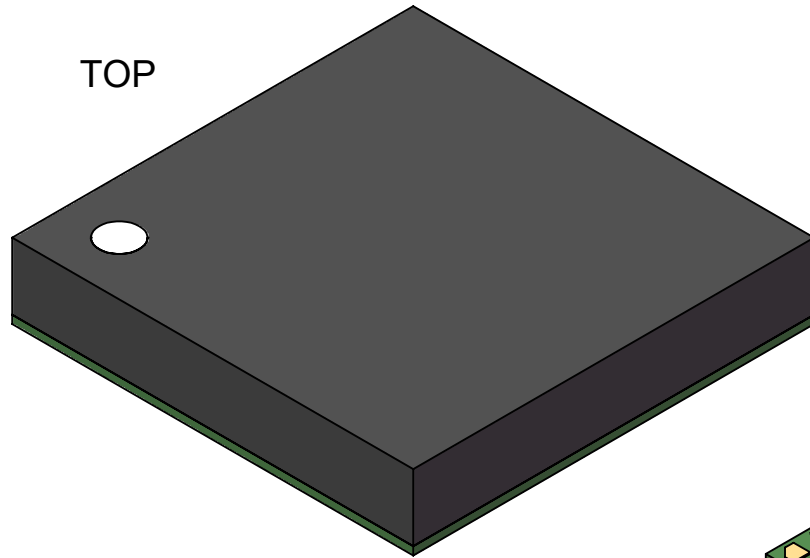
TITLE LGA144T1.27G-DC126  
DAISY CHAIN

SCALE	SIZE	DRAWING NO.	REV
16:1	A	521260	B

DO NOT SCALE DRAWING

SHEET 3 OF 5

# MODEL



**TopLine**<sup>®</sup>

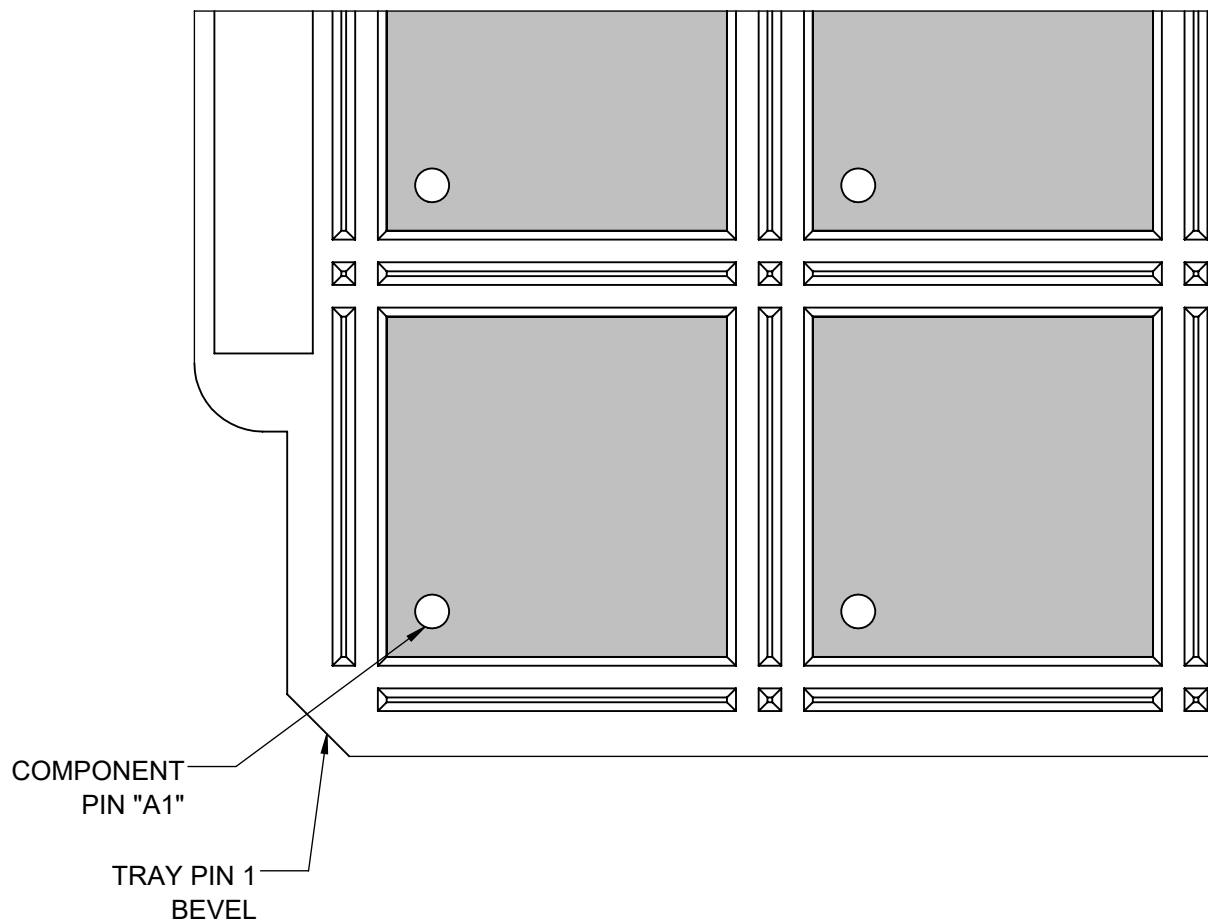
TITLE LGA144T1.27G-DC126  
DAISY CHAIN

SCALE 5:1	SIZE A	DRAWING NO. 521260	REV A
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DO NOT SCALE DRAWING

SHEET 4 OF 5

# COMPONENT ORIENTATION IN JEDEC TRAY



<b>TopLine<sup>®</sup></b>			
TITLE    LGA144T1.27G-DC126 DAISY CHAIN			
SCALE	SIZE	DRAWING NO.	REV
3:1	A	521260	A
DO NOT SCALE DRAWING			SHEET 5 OF 5